### CMOS CAMERA MODULES

your BEST camera module partner

### KLT-A3K-OV5648-3022F

**OmniVision OV5648 MIPI Interface Mise au point fixe 5MP Module de caméra** 

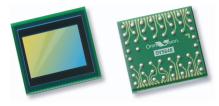


Module de caméra No.	KLT-A3K-OV5648-3022F
Capteur d'image	OV5648
EFL	3.23 mm
F.NO	2.8
Pixel	2592 X 1944
Angle de vue	75°
Type d'objectif	1/4 pouce
Dimensions de l'objectif	6.50 x 6.50 x 4.65 mm
Type de module	Mise au point fixe
Interface	MIPI



www.KaiLapTech.com sales@KaiLapTech.com Tel: (852) 6908 1256 Fax: (852) 3017 6778

All rights reserved @ Kai Lap Technologies Group Ltd. Specifications subject to change without notice.



# OV5648 5-megapixel product brief

## Cost-Efficient 5-Megapixel Camera Solution for Mainstream Mobile Devices

The OV5648 is a cost-efficient, high performance 5-megapixel CameraChip<sup>™</sup> sensor for smartphones and tablets. Utilizing OmniVision's latest 1.4-micron OmniBSI+<sup>™</sup> pixel architecture, the OV5648 combines a reduced die size with improved quality photography and high-definition (HD) video, making it ideally suited for mainstream mobile applications.

available in

a lead-free

nackage

OmniVision's powerful new OmniBSI+ pixel architecture offers significant performance improvements over our original OmniBSI™ architecture, including a 60 percent increase in full-well capacity and a significant improvement in low-light sensitivity. With OmniBSI+, the 1/4-inch OV5648 is capable of capturing high quality still images as well as 720p HD video at 60 frames per second (fps) and 1080p HD video at 30 fps.

The sensor supports a two-lane MIPI interface, and provides full-frame, windowed or binned 10-bit images in RAW RGB format with complete user control over

formatting and output transfer. It offers defective pixel canceling and all required automatic image control functions, including automatic exposure control, automatic gain control, automatic white balance, and automatic black level calibration.

A secondary image sensor may be connected to the OV5648 enabling a Video-in-Video (ViV) feature in which the secondary image is overlaid to the OV5648 output video. The combined video is streamed out over the MIPI interface. A bypass mode allows a secondary sensor to utilize the OV5648 MIPI interfaced baseband.

The OV5648 can fit into a  $6 \times 6$  mm fixed focus camera module with a z-height of less than 4.5 mm.

Find out more at www.ovt.com.



#### **Applications**

- Cellular and Picture Phones
- PC Multimedia
- Tovs
  - Digital Still Cameras

#### **Product Features**

- 1.4 µm x 1.4 µm pixel with OmniBSI+™ technology for high performance (high sensitivity, low crosstalk, low noise)
- optical size of 1/4"
- automatic image control functions - automatic exposure control (AEC) - automatic gain control (AGC) - automatic white balance (AWB) - automatic black level calibration (ABLC)
- programmable controls for frame rate, AEC/AGC 16-zone size/position/ weight control, mirror and flip, cropping, windowing, and panning
- defective pixel canceling
- support for output formats: 8-/10-bit raw RGB data
- support for LED and flash strobe mode

- support for internal and external frame synchronization for frame exposure mode
- support for horizontal and vertical sub-sampling
- standard serial SCCB interface
- MIPI interface (two lanes)
- Video-in-Video (ViV) and bypass support for secondary sensor

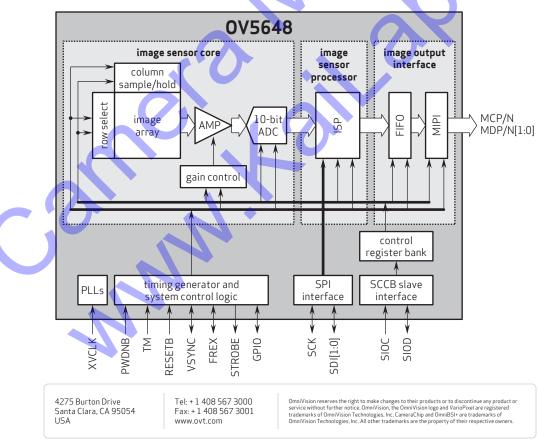
- OV05648-A53A (color, lead-free, 53-pin CSP3)
- OV05648-G04A (color, chip-probing, 200 µm backgrinding, reconstructed wafer)

#### **Product Specifications**

- active array size: 2592 x 1944
- power supply: core: 1.5V ±5% (with embedded 1.5V regulator) - analog: 2.6 - 3.0V (2.8V typical) - I/O: 1.7 - 3.0V
- operating: -30°C to 70°C junction temperature stable image: 0°C to 50°C junction

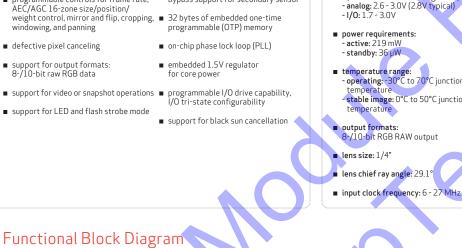
- max S/N ratio: 36 dB dynamic range: 72 dB @ 8x gain
- maximum image transfer rate:
  QSXGA (2592x1944): 15 fps
- 1080p: 30 fps
- 960p: 45 fps 720p: 60 fps
- VGA (640x480): 90 fps
- sensitivity: 690 mV/lux-sec
- shutter: rolling shutter
- **pixel size:** 1.4 μm x 1.4 μm
- dark current: 0.7 mV/s
  @ 50°C junction temperature
- image area: 3673.6 μm x 2738.4 μm
- package/die dimensions:
   CSP3: 5010 µm x 4810 µm - COB: 5000 µm x 4800 µm

#### Functional Block Diagram





Version 1.3, March, 2014



### 0V5648